



May 21, 2007

Skyworks Powers LG's Record-Selling Shine™ Phone

Second Handset in the Black Label™ Series Supported by Power Amplifier Module for Quad-Band GSM and EDGE

WOBURN, Mass., May 21, 2007 (BUSINESS WIRE) -- Skyworks Solutions, Inc. (NASDAQ:SWKS), an innovator of high performance analog and mixed signal semiconductors enabling mobile connectivity, today announced that it is supporting LG Electronics' ramp of its record-selling Shine™ handset. The Shine™, which is LG's second model from its premium Black Label Series, is leveraging the [SKY77340](#), a highly integrated quad-band EDGE power amplifier - used to support the world's largest markets in Europe and the United States. Skyworks' modules are also being utilized across LG's GPRS and CDMA Chocolate™ phones, which have sold ten million units globally since the end of 2005.

LG's Shine™ weighs a mere 115 grams, stemming from its unique stainless steel material base. Its numerous features, including expandable memory, an auto-focus, 2.0 megapixel camera, comprehensive media player, Bluetooth and USB connectivity, have also helped fuel its exceptional consumer appeal.

"Skyworks is pleased to be supporting LG across a number of their most popular platforms," said Brian M. Daly, Skyworks' vice president of marketing. "Our integrated solutions and strong capabilities across all air interfaces allow LG and other handset manufacturers to produce feature-rich mobile phones with ground-breaking technology and unique design that have proven to be very popular with consumers."

LG announced at the end of March 2007 that Shine's™ sales volume in Europe exceeded the accumulated Shine sales in the Korean market a mere month after its launch. In fact, UK retailer Phones4U named Shine its top-selling phone for the two-week period after its launch, and the handsets are also selling out in France and Germany.

About Skyworks' Power Amplifier Module

The SKY77340 PAM is designed in a compact form factor for quad-band GSM and EDGE cellular handsets. Two separate heterojunction bipolar transistor (HBT) PA blocks are fabricated onto indium gallium phosphide (InGaP) die. Inputs and outputs are impedance matched to 50 ohms, and a custom complementary metal oxide semiconductor (CMOS) integrated circuit (IC) provides internal multi function control (MFC) and interface circuitry.

The InGaP die, the silicon die, and passive components are mounted on a multi-layer laminate substrate and the assembly is encapsulated with plastic overmold. The circuitry regulates PA-bias conditions, reducing sensitivity to temperature, power supply, and process variation. The enable input signal provides a standby state to minimize battery drain. All of this comes in lead (Pb)-free, restriction of hazardous substances (RoHS)-compliant packaging.

About Skyworks

Skyworks Solutions, Inc. is an innovator of high performance analog and mixed signal semiconductors enabling mobile connectivity. The company's power amplifiers, front-end modules and direct conversion radios are at the heart of many of today's leading-edge multimedia handsets. Leveraging core technologies, Skyworks also offers a diverse portfolio of linear products that support automotive, broadband, cellular infrastructure, industrial and medical applications.

Headquartered in Woburn, Mass., Skyworks is worldwide with engineering, manufacturing, sales and service facilities throughout Asia, Europe and North America. For more information, please visit Skyworks' Web site at: www.skyworksinc.com.

Safe Harbor Statement

This news release includes "forward-looking statements" intended to qualify for the safe harbor from liability established by the Private Securities Litigation Reform Act of 1995. These forward-looking statements include information relating to future results and expectations of Skyworks (including certain projections and business trends). Forward-looking statements can often be identified by words such as "anticipates," "expects," "intends," "believes," "plans," "may," "will," "continue," similar expressions, and variations or negatives of these words. All such statements are subject to certain risks and uncertainties that could cause

actual results to differ materially and adversely from those projected, and may affect our future operating results, financial position and cash flows.

These risks and uncertainties include, but are not limited to: global economic and market conditions, such as the cyclical nature of the semiconductor industry and the markets addressed by our, and our customers', products; our ability to develop, manufacture and market innovative products in a highly price competitive and rapidly changing technological environment; fluctuations in our manufacturing yields due to our complex and specialized manufacturing processes; fluctuations in the manufacturing yields of our third party semiconductor foundries and other problems or delays in the fabrication, assembly, testing or delivery of our products; the availability and pricing of third party semiconductor foundry, assembly and test capacity and raw materials; our ability to timely and accurately predict market requirements and evolving industry standards, and to identify opportunities in new markets; losses or curtailments of purchases or payments from key customers, or the timing of customer inventory adjustments; our reliance on a several key customers for a large percentage of our sales; our ability to rapidly develop new products and avoid product obsolescence; our ability to retain, recruit and hire key executives, technical personnel and other employees in the positions and numbers, with the experience and capabilities, and at the compensation levels needed to implement our business and product plans; lengthy product development cycles that impact the timing of new product introductions; the timing, rescheduling or cancellation of significant customer orders and our ability, as well as the ability of our customers, to manage inventory; unfavorable changes in product mix; the quality of our products and any remediation costs; shorter than expected product life cycles; problems or delays that we may face in shifting our products to smaller geometry process technologies and in achieving higher levels of design integration; economic, social and political conditions in the countries in which we, our customers or our suppliers operate, including security and health risks, possible disruptions in transportation networks and fluctuations in foreign currency exchange rates; our ability to continue to grow and maintain an intellectual property portfolio and obtain needed licenses from third parties; and the uncertainties of litigation, including disputes over intellectual property, as well as other risks and uncertainties, including but not limited to those detailed from time to time in our filings with the Securities and Exchange Commission.

These forward-looking statements are made only as of the date hereof, and we undertake no obligation to update or revise the forward-looking statements, whether as a result of new information, future events or otherwise.

Note to Editors: Skyworks and Skyworks Solutions are trademarks or registered trademarks of Skyworks Solutions, Inc. or its subsidiaries in the United States and in other countries. All other brands and names listed are trademarks of their respective companies.

SOURCE: Skyworks Solutions, Inc.

Skyworks Solutions, Inc.

Media Relations:

Amanda Ingalls, 949-231-3045

or

Investor Relations:

Thomas Schiller, 949-231-4700